

MOS FIELD EFFECT TRANSISTOR 3SK230

RF AMP. FOR VHF/CATV TUNER N-CHANNEL SILICON DUAL-GATE MOS FIELD-EFFECT TRANSISTOR 4 PINS MINI MOLD

FEATURES

The Characteristic of Cross-Modulation is good.

CM = 108 dB μ (TYP.) @f = 470 MHz, GR = -30 dB

Low Noise Figure NF1 = 2.2 dB TYP. (@ = 470 MHz)

NF2 = 0.9 dB TYP. (@ = 55 MHz)

High Power Gain
 GPS = 19.5 dB TYP. (@ = 470 MHz)

· Enhancement Typ.

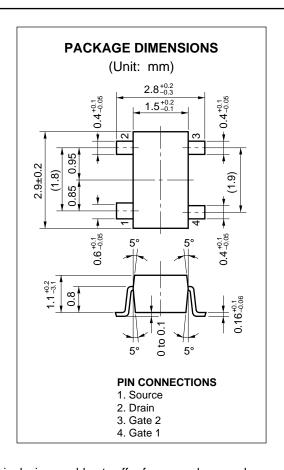
· Suitable for use as RF amplifier in CATV tuner.

· Automatically Mounting: Embossed Type Taping

· Small Package: 4 Pins Mini Mold Package. (SC-61)

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSX	18	V
Gate1 to Source Voltage	V _{G1} s	±8(±10)*1	V
Gate2 to Source Voltage	V _{G2} S	±8(±10)*1	V
Gate1 to Drain Voltage	V_{G1D}	18	V
Gate2 to Drain Voltage	V_{G2D}	18	V
Drain Current	lo	25	mΑ
Total Power Dissipation	PD	200	mW
Channel Temperature	Tch	125	°C
Storage Temperature	Tstg	-55 to +125	°C
$R_L \ge 10 \ k\Omega$			



PRECAUTION: Avoid high static voltages or electric fields so that this device would not suffer from any damage due to those voltages or fields.



ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source Breakdown Voltage	BV _{DSX}	18			V	$V_{G1S} = V_{G2S} = -2 \text{ V, ID} = 10 \ \mu\text{A}$	
Drain Current	losx	0.01		8.0	mA	V _{DS} = 6 V, V _{G2S} = 4.5 V, V _{G1S} = 0.75 V	
Gate1 to Source Cutoff Voltage	V _{G1S(off)}	0		+1.0	V	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V}, I_{D} = 10 \mu A$	
Gate2 to Source Cutoff Voltage	V _{G2S(off)}	+0.6	+1.1	+1.6	V	$V_{DS} = 6 \text{ V}, V_{G1S} = 3 \text{ V}, I_{D} = 10 \mu A$	
Gate1 Reverse Current	I _{G1SS}			±20	nA	VDS = VG2S = 0, VG1S = ±8 V	
Gate2 Reverse Current	I _{G2} SS			±20	nA	VDS = VG1S = 0, VG2S = ±8 V	
Forward Transfer Admittance	y fs	16	20	24	mS	V _{DS} = 6 V, V _{G2S} = 4.5 V, I _D = 10 mA f = 1 kHz	
Input Capacitance	Ciss	2.3	2.8	3.3	pF	V _{DS} = 6 V, V _{G2S} = 4.5 V, I _D = 10 mA f = 1 MHz	
Output Capacitance	Coss	0.9	1.2	1.5	pF		
Reverse Transfer Capacitance	Crss		0.015	0.03	pF		
Power Gain	Gps	16.5	19.5	22.5	dB	V _{DS} = 6 V, V _{G2S} = 4.5 V, I _D = 10 mA f = 470 MHz	
Noise Figure 1	NF1		2.2	3.2	dB		
Noise Figure 2	NF2		0.9	2.4	dB	V _{DS} = 6 V, V _{G2S} = 4.5 V, I _D = 10 mA f = 55 MHz	

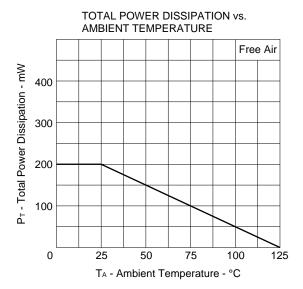
IDSX Classification

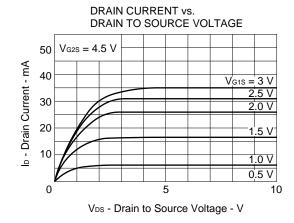
Rank	U1A	U1B		
Marking	U1A	U1B		
IDSX (mA)	0.01 to 3.0	1.0 to 8.0		

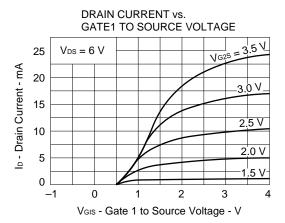
2

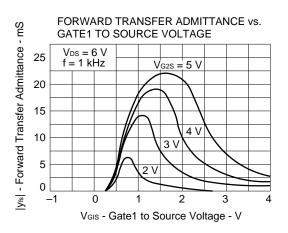


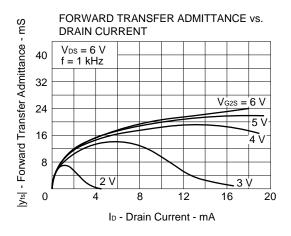
CHARACTERISTIC CURVE (TA = 25 °C)

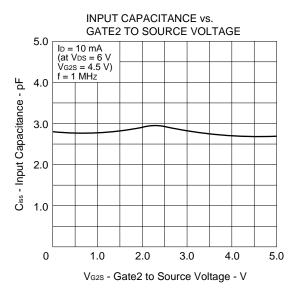




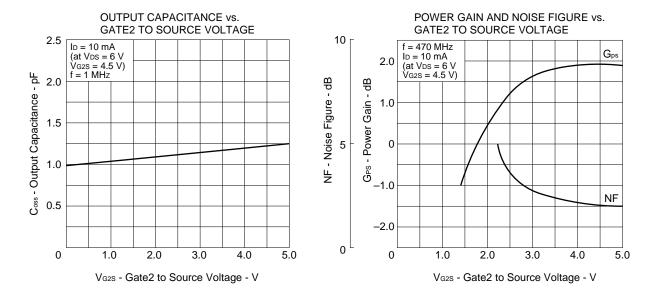












S-PARAMETER

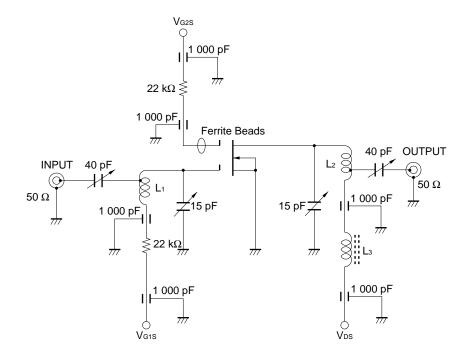
 V_{DS} = 6 V, V_{G2S} = 4.5 V, I_{D} = 10 mA, (Zo = 50 $\Omega)$

FREQUENCY	S11		S	S21		12	S22	
MHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100	1.000	-14.7	2.160	160.5	0.008	12.8	0.942	-8.2
200	0.960	-24.5	1.953	148.3	0.003	81.1	0.947	-9.6
300	0.926	-34.3	1.868	135.8	0.005	-146.8	0.906	-16.4
400	0.876	-45.0	1.760	121.2	0.003	-59.5	0.908	-19.4
500	0.853	-54.4	1.691	109.4	0.003	84.3	0.915	-25.1
600	0.842	-63.1	1.608	97.6	0.004	-87.0	0.889	-29.0

4

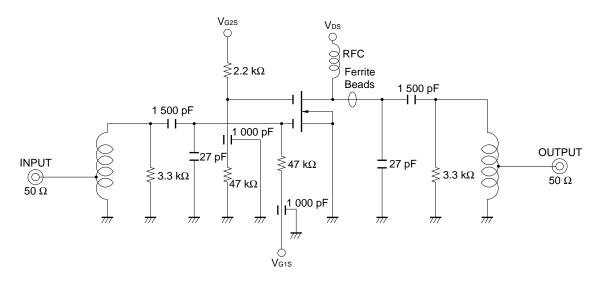


GPS AND NF TEST CIRCUIT AT f = 470 MHz



 $\begin{array}{lll} L_{1}\text{: } \phi 1.2 \text{ mm U.E.W} & \phi 5 \text{ mm IT} \\ L_{2}\text{: } \phi 1.2 \text{ mm U.E.W} & \phi 5 \text{ mm IT} \\ L_{3}\text{: REC 2.2 } \mu \text{H} \end{array}$

NF TEST CIRCUIT AT f = 55 MHz



5

[MEMO]

[MEMO]

[MEMO]

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.

NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

M4 96.5